

DIM400PHM17-A000

Half Bridge IGBT Module

DS5561-4 August 2017 (LN34663)

Replaces DS5561-3

FEATURES

- 10µs Short Circuit Withstand
- High Thermal Cycling Capability
- Non Punch Through Silicon
- Isolated AISiC Base with AIN Substrates
- Lead Free construction

APPLICATIONS

- Matrix Converters
- **Brushless Motor Controllers**
- Frequency Converters

The Powerline range of high power modules includes half bridge, chopper, dual, single and bi-directional switch configurations covering voltages from 1200V to 6500V and currents up to 2400A.

The DIM400PHM17-A000 is a half bridge 1700V, nchannel enhancement mode, insulated gate bipolar transistor (IGBT) module. The IGBT has a wide reverse bias safe operating area (RBSOA) plus 10µs short circuit withstand. This device is optimised for applications requiring high thermal cycling capability.

The module incorporates an electrically isolated base plate and low inductance construction enabling circuit designers to optimise circuit layouts and utilise grounded heat sinks for safety.

ORDERING INFORMATION

Order As:

DIM400PHM17-A000

Note: When ordering, please use the complete part number

KEY PARAMETERS

V_{DRM}		1700\
$V_{\text{CE(sat)}}^*$	(typ)	2.7V
I _C	(max)	400A
I _{C(PK)}	(max)	800A

^{*} Measured at the power busbars, not the auxiliary terminals

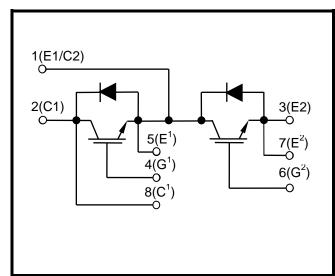


Fig. 1 Circuit configuration

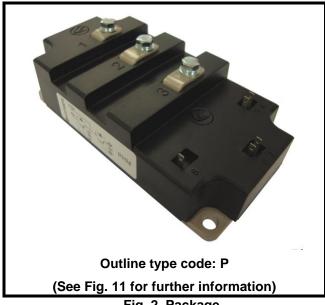


Fig. 2 Package

ABSOLUTE MAXIMUM RATINGS

Stresses above those listed under 'Absolute Maximum Ratings' may cause permanent damage to the device. In extreme conditions, as with all semiconductors, this may include potentially hazardous rupture of the package. Appropriate safety precautions should always be followed. Exposure to Absolute Maximum Ratings may affect device reliability.

T_{case} = 25°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
V _{CES}	Collector-emitter voltage	V _{GE} = 0V	1700	V
V_{GES}	Gate-emitter voltage		±20	V
I _C	Continuous collector current	T _{case} = 75°C	400	Α
I _{C(PK)}	Peak collector current	1ms, T _{case} = 110°C	800	Α
P _{max}	Max. transistor power dissipation	$T_{case} = 25^{\circ}C, T_{j} = 150^{\circ}C$	3470	W
l ² t	Diode I ² t value	$V_R = 0$, $t_p = 10$ ms, $T_j = 125$ °C	30	kA ² s
V _{isol}	Isolation voltage – per module	Commoned terminals to base plate. AC RMS, 1 min, 50Hz	4000	V
Q_{PD}	Partial discharge – per module	IEC1287, V ₁ = 1800V, V ₂ = 1300V, 50Hz RMS	10	рC

THERMAL AND MECHANICAL RATINGS

Internal insulation material:

Baseplate material:

Creepage distance:

Clearance:

CTI (Comparative Tracking Index):

AIN

AISiC

33mm

20mm

>600

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
R _{th(j-c)}	Thermal resistance – transistor	Continuous dissipation - junction to case	-	-	36	°C/kW
R _{th(j-c)}	Thermal resistance – diode	Continuous dissipation - junction to case	-		80	°C/kW
R _{th(c-h)}	Thermal resistance – case to heatsink (per module)	Mounting torque 5Nm (with mounting grease)	-	ı	16	°C/kW
T _j	Junction temperature	Transistor	-	-	150	°C
		Diode	-	-	125	°C
T _{stg}	Storage temperature range	-	-40	-	125	°C
	Screw torque	Mounting – M6	-	-	5	Nm
		Electrical connections – M5	-	-	4	Nm

ELECTRICAL CHARACTERISTICS

 T_{case} = 25°C unless stated otherwise.

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
I _{CES}	Collector cut-off current	$V_{GE} = 0V$, $V_{CE} = V_{CES}$			1	mA
		$V_{GE} = 0V$, $V_{CE} = V_{CES}$, $T_{case} = 125$ °C			12	mA
I _{GES}	Gate leakage current	$V_{GE} = \pm 20V, V_{CE} = 0V$			2	μA
V _{GE(TH)}	Gate threshold voltage	$I_C = 20$ mA, $V_{GE} = V_{CE}$	4.5	5.5	6.5	V
	Collector-emitter	V _{GE} = 15V, I _C = 400A		2.7	3.2	V
V _{CE(sat)}	saturation voltage	V _{GE} = 15V, I _C = 400A, T _j = 125°C		3.4	4.0	V
I _F	Diode forward current	DC			400	Α
I _{FM}	Diode maximum forward current	t _p = 1ms			800	Α
	Diode forward voltage	I _F = 400A		2.2	2.5	V
V_{F}		I _F = 400A, T _j = 125°C		2.3	2.6	V
C _{ies}	Input capacitance	$V_{CE} = 25V, V_{GE} = 0V, f = 1MHz$		30		nF
Qg	Gate charge	±15V		4.5		μC
C _{res}	Reverse transfer capacitance	$V_{CE} = 25V, V_{GE} = 0V, f = 1MHz$				nF
L _M	Module inductance			20		nΗ
R _{INT}	Internal resistance			270		μΩ
SC _{Data}	Short circuit current, I _{SC}	$T_{j} = 125^{\circ}C, V_{CC} = 1000V$ $t_{p} \le 10\mu s, V_{GE} \le 15V$ $V_{CE (max)} = V_{CES} - L^{*}x dI/dt$ IEC 60747-9		1600		А

Note:

L is the circuit inductance + L_{M}

ELECTRICAL CHARACTERISTICS

T_{case} = 25°C unless stated otherwise

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
t _{d(off)}	Turn-off delay time			1150		ns
t _f	Fall time	$I_{C} = 400A$ $V_{GF} = \pm 15V$		100		ns
E _{OFF}	Turn-off energy loss	$V_{GE} = £13V$ $V_{CE} = 900V$		120		mJ
t _{d(on)}	Turn-on delay time	$R_{G(ON)} = 4.7\Omega$		250		ns
t _r	Rise time	$R_{G(OFF)} = 4.7\Omega$ $L_{S} \sim 100 \text{nH}$		250		ns
E _{ON}	Turn-on energy loss	25 100111		150		mJ
Q_{rr}	Diode reverse recovery charge	I _F = 400A		100		μC
I _{rr}	Diode reverse recovery current	V _{CE} = 900V		230		Α
E _{rec}	Diode reverse recovery energy	$dI_F/dt = 3000A/\mu s$		70		mJ

T_{case} = 125°C unless stated otherwise

Symbol	Parameter	Test Conditions	Min	Тур.	Max	Units
$t_{d(off)}$	Turn-off delay time	$I_{C} = 400A$ $V_{GF} = \pm 15V$		1400		ns
t _f	Fall time			130		ns
E _{OFF}	Turn-off energy loss	$V_{GE} = £13V$ $V_{CE} = 900V$		180		mJ
t _{d(on)}	Turn-on delay time	$R_{G(ON)} = 4.7\Omega$		400		ns
t _r	Rise time	$R_{G(OFF)} = 4.7\Omega$ $L_S \sim 100$ nH		250		ns
E _{ON}	Turn-on energy loss	25 1001111		170		mJ
Q_{rr}	Diode reverse recovery charge	I _F = 400A		170		μC
I _{rr}	Diode reverse recovery current	$V_{CE} = 900V$		270		Α
E _{rec}	Diode reverse recovery energy	$dI_F/dt = 2500A/\mu s$		100		mJ

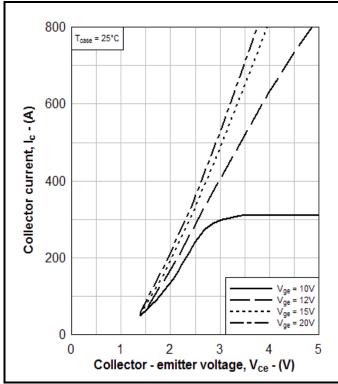


Fig. 3 Typical output characteristics

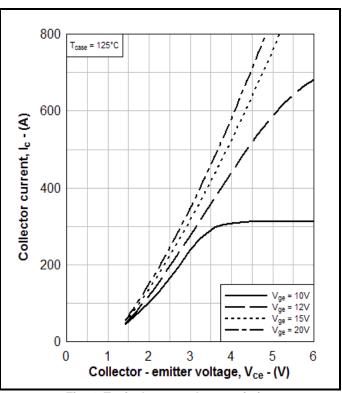


Fig. 4 Typical output characteristics

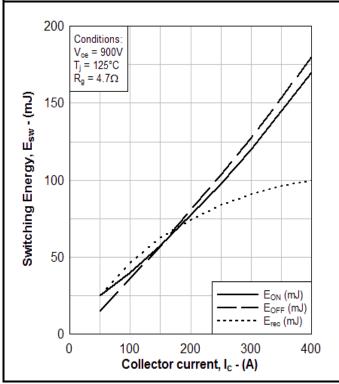


Fig. 5 Typical switching energy vs collector current

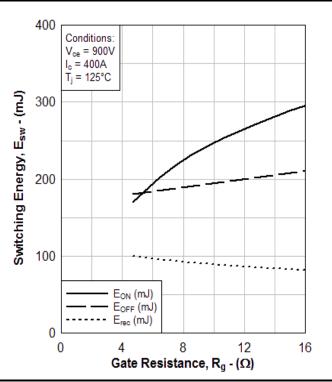


Fig. 6 Typical switching energy vs gate resistance

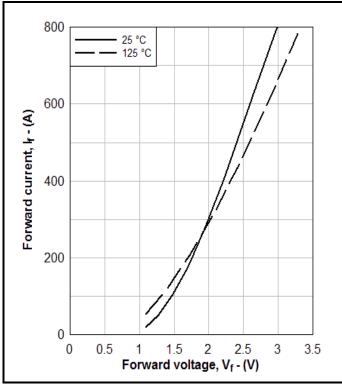


Fig. 7 Diode typical forward characteristics

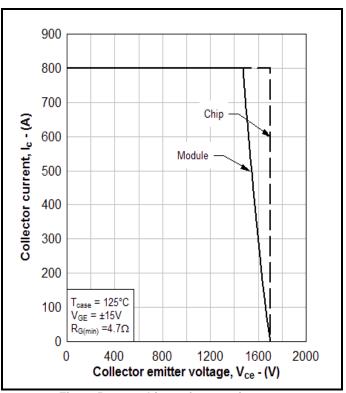


Fig. 8 Reverse bias safe operating area

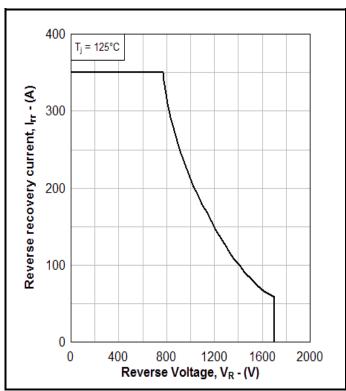


Fig. 9 Diode reverse bias safe operating area

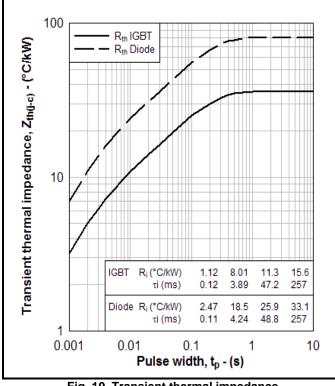


Fig. 10 Transient thermal impedance

PACKAGE DETAILS

For further package information, please visit our website or contact Customer Services. All dimensions in mm, unless stated otherwise.

DO NOT SCALE.

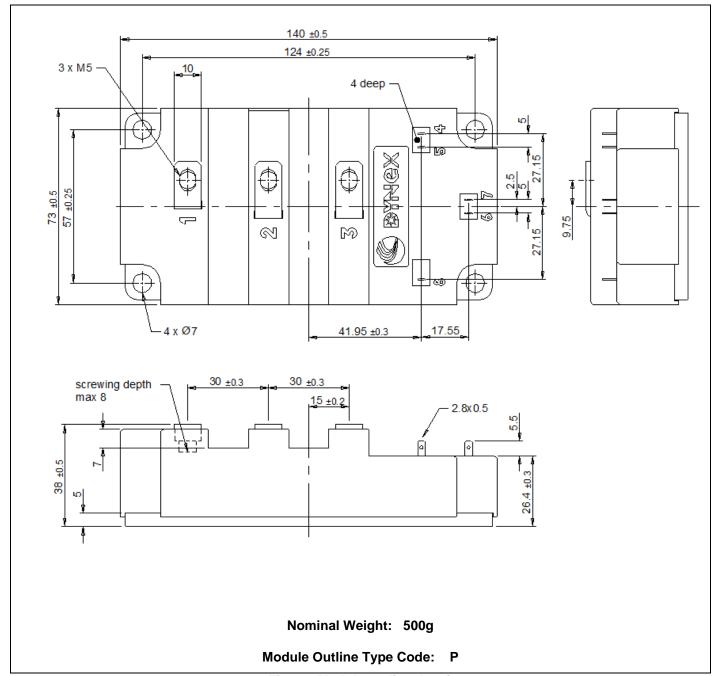


Fig. 11 Module outline drawing

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